

Microprocessor Voltage Monitor with Manual Reset

Features

- Precision monitoring of +3V, +3.3V, and +5V power-supply voltages
- Fully specified over temperature
- Available in two output configurations
 - Push-pull $\overline{\text{RESET}}$ output (SS8039L)
 - Push-pull RESET output (SS8039H)
- Manual reset input
- Power-on reset pulse width of 140ms min
- Supply current of 5 μ A
- Guaranteed reset valid to $V_{CC} = +1V$
- Power supply transient immunity
- No external components
- 4-Pin SOT-143 package

Applications

- Computers
- Controllers
- Intelligent instruments
- Critical μ P and μ C power monitoring
- Portable / battery-powered equipment
- Automotive

Compatible with the popular "811" series

General Description

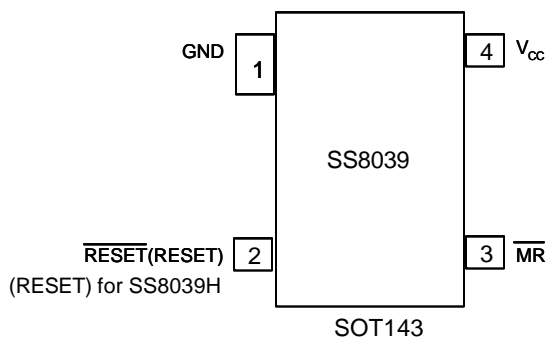
The SS8039 is a microprocessor (μ P) supervisory circuit used to monitor the power supplies in μ P and digital systems. It provides excellent circuit reliability and low cost by eliminating external components and adjustments when used with +5V, +3.3V, +3.0V- powered circuits.

These circuits perform a single function: they assert a reset signal whenever the V_{CC} supply voltage declines below a preset threshold, keeping it asserted for at least 140ms after V_{CC} has risen above the reset threshold. Reset thresholds suitable for operation with a variety of supply voltages are available.

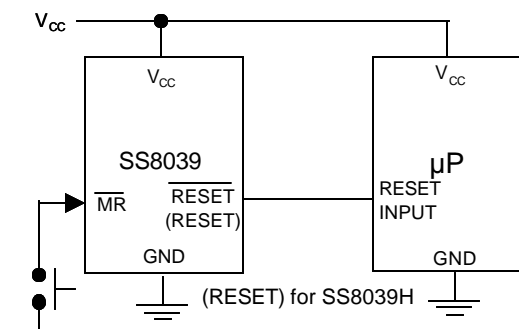
The SS8039 has a push-pull output stage. The SS8039L has an active-low $\overline{\text{RESET}}$ output, while the SS8039H has an active-high RESET output. The reset comparator is designed to ignore fast transients on V_{CC} , and the outputs are guaranteed to be in the correct logic state for V_{CC} down to 1V.

Low supply current makes the SS8039 ideal for use in portable equipment, and it is available in a 4-pin SOT-143 package.

Pin Configuration

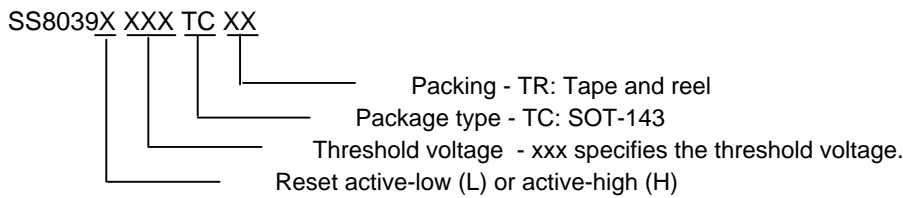


Typical Application



Ordering Information

Options are released to production as needed. Please check with Silicon Standard for availability.



Example: SS8039H263TCTR

SS8039 with push-pull active-high reset output at 2.63V in SOT-143 package supplied on tape and reel

Absolute Maximum Ratings

Terminal voltages with respect to GND

V_{CC}-0.3V to +6.0V
 RESET, $\overline{\text{RESET}}$ (push-pull).....-0.3V to (V_{CC} + 0.3V)
 Input Current, V_{CC}20mA
 Output Current, RESET, $\overline{\text{RESET}}$ 20mA

Continuous Power Dissipation ($T_A = +70^\circ\text{C}$)
 SOT-143 (derate 4mW/ $^\circ\text{C}$ above +70 $^\circ\text{C}$).....320mW
 Operating Temperature Range-40 $^\circ\text{C}$ to +105 $^\circ\text{C}$
 Storage Temperature Range..... -65 $^\circ\text{C}$ to +150 $^\circ\text{C}$
 Lead Temperature (soldering, 10s)+300 $^\circ\text{C}$

Electrical Characteristics

(V_{CC} = full range, $T_A = -40^\circ\text{C}$ to +105 $^\circ\text{C}$, unless otherwise noted. Typical values are at $T_A = +25^\circ\text{C}$, $V_{CC} = 5\text{V}$ for 463/438/400 versions, $V_{CC} = 3.3\text{V}$ for 308/293 versions, and $V_{CC} = 3\text{V}$ for 263 version.) (Note 1)

PARAMETER	SYMBOL	CONDITION		MIN	TYP	MAX	UNITS
V_{CC} Range		$T_A = 0^\circ\text{C} +70^\circ\text{C}$		1.0		5.5	V
		$T_A = -40^\circ\text{C} +105^\circ\text{C}$		1.2		5.5	
Supply Current	I_{CC}	$T_A = -40^\circ\text{C} +105^\circ\text{C}$	$V_{CC} < 5.5\text{V}$, SS8039x463/438/400		5.5	9	μA
			$V_{CC} < 3.6\text{V}$, SS8039x308/293/263		5	8	
Reset Threshold	V_{TH}	SS8039x463	$T_A = +25^\circ\text{C}$	4.537	4.63	4.722	V
		SS8039x438	$T_A = +25^\circ\text{C}$	4.292	4.38	4.467	
		SS8039x400	$T_A = +25^\circ\text{C}$	3.92	4.00	4.08	
		SS8039x308	$T_A = +25^\circ\text{C}$	3.018	3.08	3.141	
		SS8039x293	$T_A = +25^\circ\text{C}$	2.871	2.93	2.988	
		SS8039x263	$T_A = +25^\circ\text{C}$	2.577	2.63	2.682	

Electrical Characteristics (Continued)

(V_{CC} = full range, T_A = -40°C to +105°C, unless otherwise noted. Typical values are at T_A = +25°C, V_{CC} = 5V for 463/438/400 versions, V_{CC} = 3.3V for 308/293 versions, and V_{CC} = 3V for 263 version.) (Note 1)

PARAMETER	SYMBOL	CONDITION	MIN	TYP	MAX	UNITS
Reset Threshold Tempco				70		ppm/°C
V_{CC} to Reset Delay (Note 2)		$V_{CC} = V_{TH}$ to $(V_{TH} - 100\text{mV})$		15		
Reset Active Timeout Period		$V_{CC} = V_{TH}$ max, SS8039x463/438/400	250	510	720	ms
		$V_{CC} = V_{TH}$ max, SS8039x308/293/263	140	310	520	
$\overline{\text{MR}}$ Minimum Pulse Width	t_{MR}			10		μs
$\overline{\text{MR}}$ Glitch Immunity (Note 3)				100		ns
$\overline{\text{MR}}$ to Reset Propagation Delay (Note 2)	t_{MD}			0.5		μs
$\overline{\text{MR}}$ Input Threshold	V_{IH}	$V_{CC} > V_{TH(\text{max})}$	$0.6 \times V_{CC}$			V
	V_{IL}			$0.25 \times V_{CC}$		
$\overline{\text{MR}}$ Pull-up Resistance			10	20	30	KΩ
RESET Output Current Low (push-pull active low, SS8039L)	I_{OL}	$V_{CC} = 2.5\text{V}, V_{\overline{\text{RESET}}} = 0.5\text{V}$	8			mA
RESET Output Current High (push-pull active low, SS8039L)	I_{OH}	$V_{CC} = 5\text{V}, V_{\overline{\text{RESET}}} = 4.5\text{V}, \text{SS8039L463/438/400}$	4.5			mA
		$V_{CC} = 3.3\text{V}, V_{\overline{\text{RESET}}} = 2.8\text{V}, \text{SS8039L308/293}$	3			
		$V_{CC} = 3\text{V}, V_{\overline{\text{RESET}}} = 2.5\text{V}, \text{SS8039L263}$	2			
RESET Output Current Low (push-pull active high, SS8039H)	I_{OL}	$V_{CC} = 5\text{V}, V_{\overline{\text{RESET}}} = 0.5\text{V}, \text{SS8039H463/438/400}$	16			mA
		$V_{CC} = 3.3\text{V}, V_{\overline{\text{RESET}}} = 0.5\text{V}, \text{SS8039H308/293}$	12			
		$V_{CC} = 3\text{V}, V_{\overline{\text{RESET}}} = 0.5\text{V}, \text{SS8039H263}$	10			
RESET Output Current High (push-pull active high, SS8039H)	I_{OH}	$V_{CC} = 2.5\text{V}, V_{\overline{\text{RESET}}} = 2\text{V}$	2			mA

Note 1: Production testing done at T_A = +25°C; limits over temperature guaranteed by design.

Note 2: RESET output is for SS8039L; RESET output is for SS8039H.

Note 3: "Glitches" of 100ns or less typically will not generate a reset pulse.

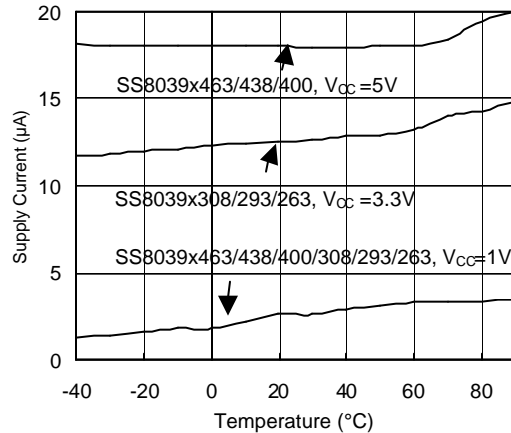
Selection Guide and Part Marking

PART/SUFFIX	RESET THRESHOLD (V)	OUTPUT TYPE	TOP MARK
SS8039H463TC	4.63	Push-Pull RESET	692Lx
SS8039H438TC	4.38	Push-Pull RESET	692Kx
SS8039H400TC	4.00	Push-Pull RESET	692Jx
SS8039H308TC	3.08	Push-Pull RESET	692Ix
SS8039H293TC	2.93	Push-Pull RESET	692Hx
SS8039H263TC	2.63	Push-Pull RESET	692Gx
SS8039L463TC	4.63	Push-Pull $\overline{\text{RESET}}$	692Fx
SS8039L438TC	4.38	Push-Pull $\overline{\text{RESET}}$	692Ex
SS8039L400TC	4.00	Push-Pull $\overline{\text{RESET}}$	692Dx
SS8039L308TC	3.08	Push-Pull $\overline{\text{RESET}}$	692Cx
SS8039L293TC	2.93	Push-Pull $\overline{\text{RESET}}$	692Bx
SS8039L263TC	2.63	Push-Pull $\overline{\text{RESET}}$	692Ax

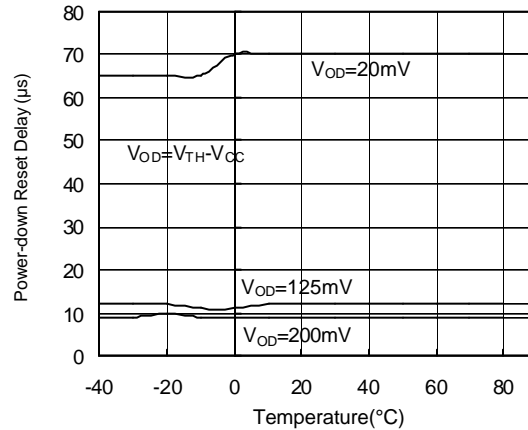
Typical Operating Characteristics

(V_{CC} = full range, T_A = -40°C to $+105^{\circ}\text{C}$, unless otherwise noted. Typical values are at T_A = $+25^{\circ}\text{C}$, V_{CC} = 5V for 463/438/400 versions, V_{CC} = 3.3V for 308/293 versions, and V_{CC} = 3V for 263 version.)

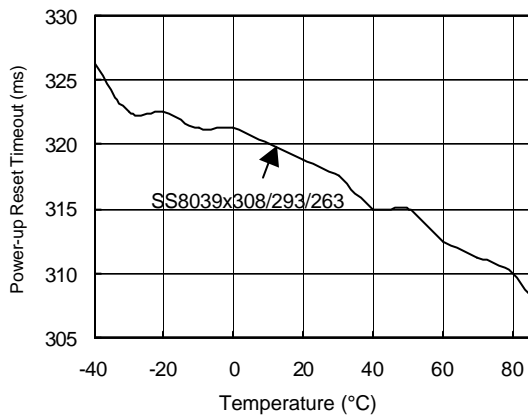
**Supply Current vs. Temperature
(No Load)**



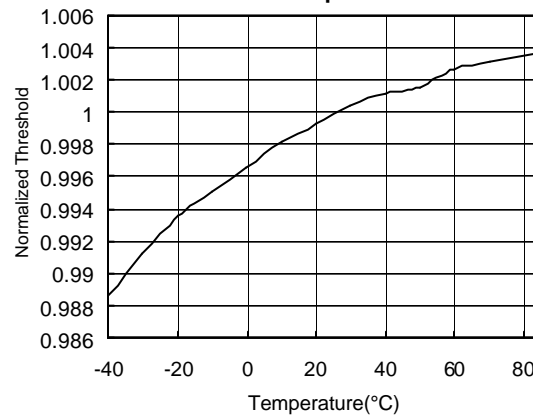
**Power-down Reset Delay vs. Temperature
(SS8039x308/293/263)**



**Power-up Reset Timeout
vs. Temperature**



**Normalized Reset Threshold
vs. Temperature**



Pin Description

PIN	NAME	FUNCTION
1	GND	Ground
2	$\overline{\text{RESET}}$ (SS8039L)	$\overline{\text{RESET}}$ Output remains low while V_{CC} is below the reset threshold, and for at least 140ms after V_{CC} rises above the reset threshold.
	RESET (SS8039H)	RESET Output remains high while V_{CC} is below the reset threshold, and for at least 140ms after V_{CC} rises above the reset threshold.
3	$\overline{\text{MR}}$	Manual Reset Input. A logic low on $\overline{\text{MR}}$ asserts reset. Reset remains asserted as long as $\overline{\text{MR}}$ is low and for at least 140ms after $\overline{\text{MR}}$ returns high, This active-low input has an internal 20k Ω pull-up resistor. It can be driven from a TTL or CMOS-logic line, or shorted to ground with a switch. Leave open if unused.
4	V_{CC}	Supply Voltage (+5V, +3.3V, +3.0V)

Detailed Description

A microprocessor's (μP 's) reset input starts the μP in a known state. The SS8039L and SS8039H assert reset to prevent code-execution errors during power-up, power-down, or brownout conditions. They assert a reset signal whenever the V_{CC} supply voltage declines below a preset threshold, keeping it asserted for at least 140ms after V_{CC} has risen above the reset threshold.

The SS8039L/SS8039H have a push-pull output stage. The manual reset input (MR) can also initiate a reset. See the Manual Reset Input Section.

Manual Reset Input

Many μP -based products require manual reset capability allowing the operator, a test technician, or external logic circuitry to initiate a reset. A logic low on $\overline{\text{MR}}$ asserts reset. Reset remains asserted while $\overline{\text{MR}}$ is low, and for the Reset Active Timeout Period (t_{RP}) after $\overline{\text{MR}}$ returns high. This input has an internal 20k Ω pull-up resistor, so it can be left open if it is not used. $\overline{\text{MR}}$ can be driven with TTL or CMOS-logic levels, or with open-drain / collector outputs. Connect a normally open momentary switch from $\overline{\text{MR}}$ to GND to create a manual-reset function; external debounce circuitry is not required. If $\overline{\text{MR}}$ is driven from long cables or if the device is used in a noisy environment, connecting a 0.1 μF capacitor from $\overline{\text{MR}}$ to ground provides additional noise immunity.

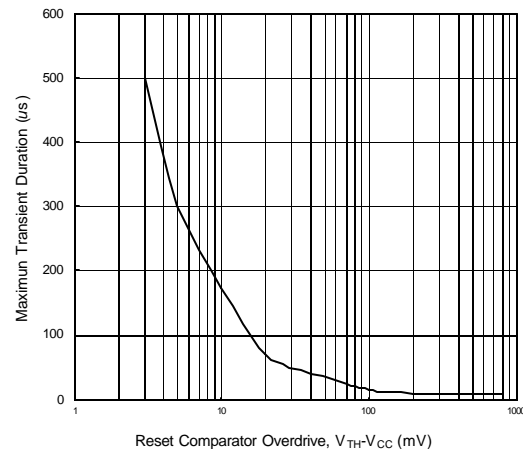


Fig.1 Maximum Transient Duration Without Causing a Reset Pulse vs. Reset Comparator Overdrive

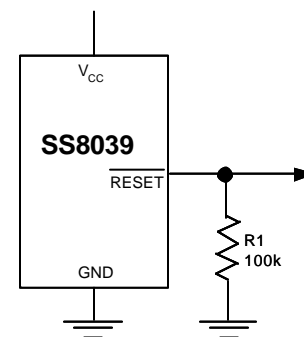


Figure2. $\overline{\text{RESET}}$ Valid to $V_{CC} = \text{Ground}$ Circuit

Applications Information

Negative-Going V_{CC} Transients

In addition to issuing a reset to the μP during power-up, power-down, and brownout conditions, the SS8039H and SS8039L are relatively immune to short-duration negative-going V_{CC} transients (glitches).

Figure 1 shows typical transient durations, vs. the reset comparator overdrive, for which both the SS8039H and SS8039L do not generate a reset pulse. The graph was generated using a negative-going pulse applied to V_{CC} , starting 0.5V above the actual reset threshold and ending below it by the magnitude indicated (reset comparator overdrive). The graph indicates the maximum pulse width a negative-going V_{CC} transient can have without causing a reset pulse. As the magnitude of the transient increases (goes farther below the reset threshold), the maximum allowable pulse width decreases. For the SS8039x463 and SS8039x438, a V_{CC} transient that goes 100mV below the reset threshold and lasts 15 μs or less will not typically cause a reset pulse. A 0.1 μF bypass capacitor mounted as close as possible to the V_{CC} pin provides additional transient immunity.

Ensuring a Valid Reset Output Down to $V_{CC} = 0$

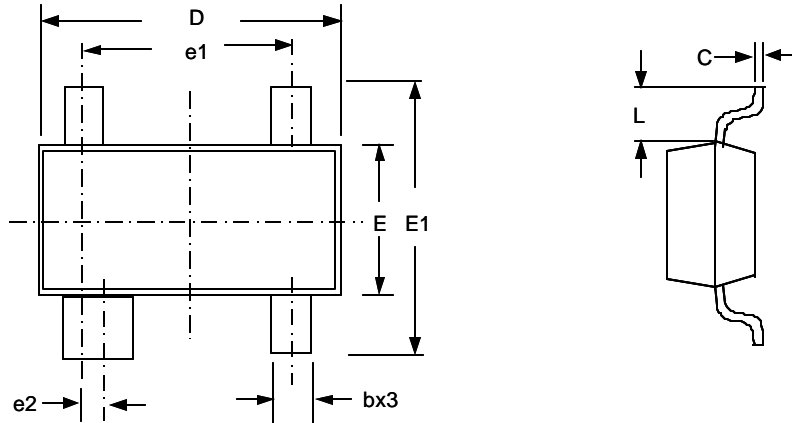
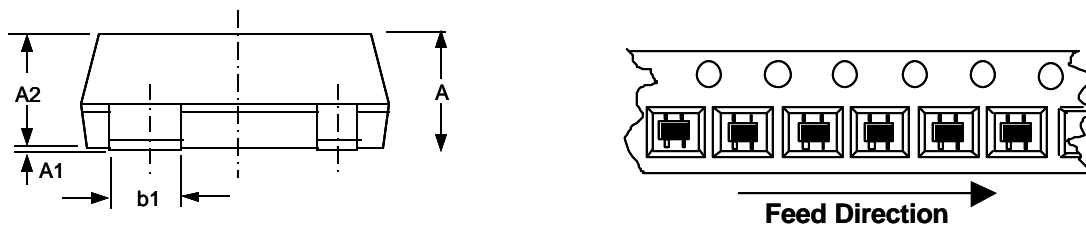
When V_{CC} falls below 1V, the SS8039 \overline{RESET} output no longer sinks current—it becomes an open circuit. Therefore, high-impedance CMOS logic inputs connected to \overline{RESET} can drift to undetermined voltages. This presents no problem in most applications since most μP and other circuitry is inoperative with V_{CC} below 1V. However, in applications where \overline{RESET} must be valid down to 0V, adding a pull-down resistor to \overline{RESET} causes any stray leakage currents to flow to ground, holding \overline{RESET} low (Figure 2). R1's value is not critical; 100k Ω is large enough not to load \overline{RESET} and small enough to pull \overline{RESET} to ground.

Benefits of Highly Accurate Reset Threshold

Most μP supervisor ICs have reset threshold voltages between 5% and 10% below the value of nominal supply voltages. This ensures a reset will not occur within 5% of the nominal supply, but will occur when the supply is 10% below nominal.

When using ICs rated at only the nominal supply $\pm 5\%$, this leaves a zone of uncertainty where the supply is between 5% and 10% low, and where the reset may or may not be asserted.

The SS8039x uses highly accurate circuitry to ensure that reset is asserted close to the 5% limit, and long before the supply has declined to 10% below nominal.

Physical Dimensions

Package Orientation

SOT 143 Package

SYMBOL	DIMENSION IN MILLIMETERS		DIMENSION IN INCHS	
	MIN.	MAX.	MIN.	MAX.
A	0.95	1.20	0.037	0.047
A1	0.05	0.10	0.002	0.004
A2	0.90	1.10	0.035	0.043
b	0.37	0.46	0.145	0.018
b1	0.76	0.89	0.030	0.035
C	0.10	0.18	0.004	0.007
D	2.80	3.04	0.110	0.120
E	1.20	1.40	0.047	0.055
E1	2.30	2.50	0.091	0.098
e1	1.92 BSC.		0.75 BSC.	
e2	0.20 BSC.		0.078 BSC.	
L	0.69 REF.		0.27 REF.	

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